

### Fast recovery diode Reverse Voltage1000v Forward current-3A

#### **Features**

Glass passivated chip
High surge current capability
Ldeal for surface mounted applications
Low power loss, high efficiency
Plastic Case Material has UL Flammability

### Mechanical Data

Package: SMC

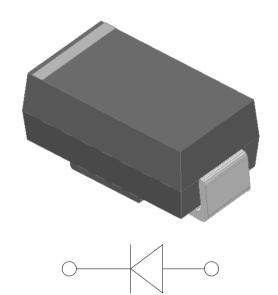
Terminals:Tin Plated leads, solderable per

Mil-STD-750 Method 2026

Polarity: As marked

Molding compound meets UL 94 V-0 flammability rating,

**ROHS-compliant** 



### Maximum Ratings (Ta=25 ℃ Unless otherwise specified)

Type Number	SYMBOL	RS3MC	Umit	
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	1000	V	
Maximum RMS Voltage	V <sub>RMS</sub>	700	V	
Maximum DC Blocking Voltage	V <sub>DC</sub>	1000	V	
Maximum Average Forward Rectified Current	IO <sub>(AV)</sub>	3.0	Α	
Peak Forward Surge Current 8.3ms Single half-sine-wave superimposed on rated load(JEDEC Method) on rated	IFSM _	80.0	А	
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25 ℃	II OW	160.0	А	
Current squared time @1ms≤t8.3≤ms Tj=25℃,Rating of per diode	l <sup>2</sup> t	26.6	A <sup>2</sup> S	
Maximum Forward Voltage at 3.0A DC	V <sub>FM</sub>	1.30	V	
Maximum Reverse Current TA = 25 ℃	ID	5.0		
at Rated DC Blocking Voltage TA = 125℃	IR -	100.0	- uA	
Maximum reverse recovery time	Trr	500.0	ns	
Typical Thermal Resistance Between junction and	$R_{QJa}$	48.0	°C/W	
Operating Junction Temperature Range	T <sub>J</sub>	55to+150	$^{\circ}$	
Storage Temperature Range	T <sub>STG</sub>	—55to+150	$^{\circ}$	



# 四川旭茂微科技有限公司

Sichuan Xu Mao Micro Technology Co., Ltd

RS3MC

FIG. 1MAXIMUM AVERAGE FORWARD CURRENT DERATING

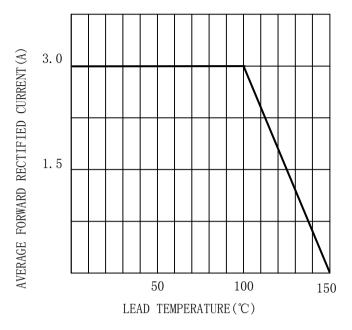


FIG. 2TYPICAL FORWARD CHARACTERISTICS

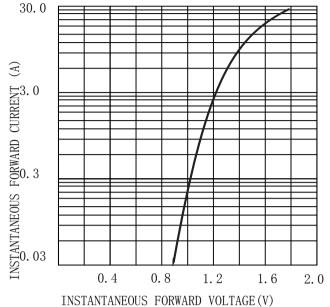


FIG. 3MAXIMUM NON-REPEITIVE SURGE CURRENT

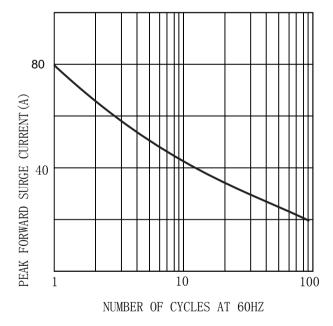
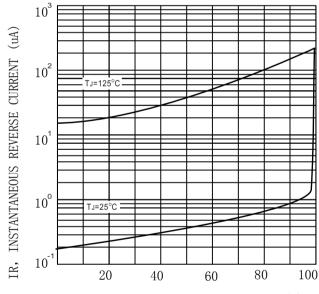


FIG. 4 TYPICAL REVERSE CHARACTERISTICS (per element)



PERCENT OF RATED PEAK REVERSE VOLTAGE (%)



## **MARKING INFORMATION**



🤝 = Logo

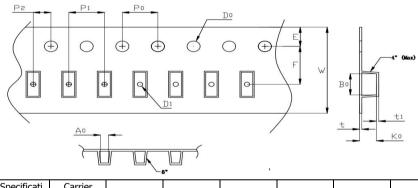
\*\*\*\* = Date Code Marking

RS3M = Marking Code

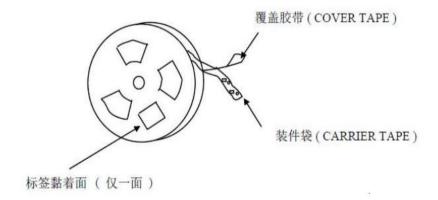
Print according to customer request

# **PACKING REQUIRMENTS**

Carrier tape packing



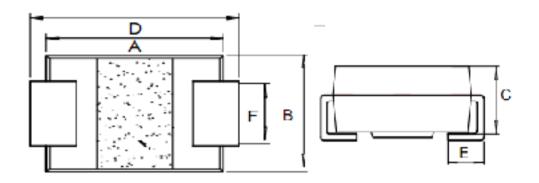
Specificati ons	Carrier tape type	Ao	Во	Ко	Ро	W	t	Exiplain
SMC	Anti-static	6.05±0.1	8.31±0.1	2.54±0.1	3.98±0.05	15.95±0.05	0.23±0.02	



	DEVICE TYPE	Tape width	`Reel			
			Q'TY/REEL (pcs)	BOX/CAR TOON	Q'TY/REEL (pcs)	
	SMC	13.3	3000	T/R	3000	



# Outline Dimensions



SMC					
DTM	INC HES		MM		
DIM	MIN	MAX	MIN	MAX	
A	0.26	0. 28	6.6	7. 1	
В	0.22	0. 24	5. 5	6. 2	
С	0.08	0.10	2	2.6	
D	0.30	0.32	7. 7	8.2	
Е	/	0.06	/	1.5	
F	0.11	0. 13	2.9	3. 2	

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